

M1253 Surface Mount Crystal

2.5 x 3.2 x 0.8 mm



Features:

- Ultra-Miniature Size
- Tape & Reel
- Leadless Ceramic Package - Seam Sealed

Applications:

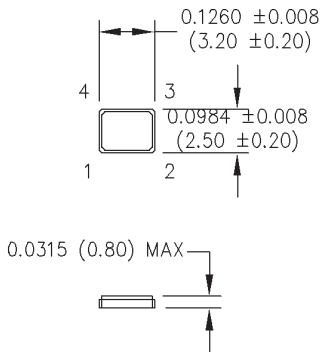
- Handheld Electronic Devices
- PDA, GPS, MP3
- Portable Instruments
- PCMCIA Cards
- Bluetooth



Ordering Information

Product Series	M1253	6	J	M	XX	00.0000
Operating Temperature	1: -10°C to +70°C	3: -10°C to +60°C				MHz
	2: -40°C to +85°C	6: -20°C to +70°C				
Tolerance @ +25°C	D: ±10 ppm	J: ±30 ppm (std)				
	E: ±15 ppm	M: ±50 ppm				
	G: ±20 ppm	P: ±100 ppm				
	H: ±25 ppm					
Stability	D: ±10 ppm	J: ±30 ppm				
	E: ±15 ppm	M: ±50 ppm (std)				
	G: ±20 ppm	P: ±100 ppm				
	H: ±25 ppm					
Load Capacitance	Blank: 18 pF (std)					
	S: Series Resonant					
	XX: Customer Specified 8 pF to 32 pF					
Frequency (customer specified)						

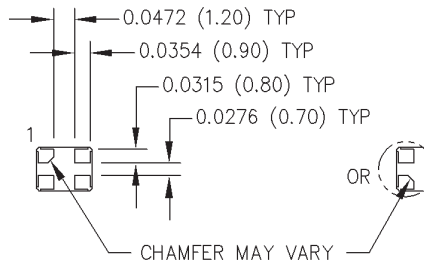
M1253Sxxx - Contact factory for datasheet.



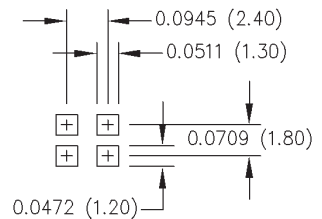
(TOP VIEW)
INTERNAL
CONNECTIONS

(2 & 4 connected
thru metal cover)

All dimensions
in inches (mm).



SUGGESTED SOLDER PAD LAYOUT



	Parameter	Symbol	Min.	Typ.	Max.	Units	Conditions
Electrical Specifications	Frequency Range	F	12		54	MHz	
	Frequency Tolerance	F/F	See Ordering Information			ppm	+25°C
	Frequency Stability	F/F	See Ordering Information			ppm	Over Operating Temperature
	Operating Temperature	T _{opr}	See Ordering Information			°C	
	Storage Temperature	T _{stg}	-55		+125	°C	
	Aging	F _a			±5	ppm/yr	+25°C
	Load Capacitance	C _L					See Ordering Information
	Shunt Capacitance	C ₀			3	pF	
	ESR						
		Fundamental AT-Cut Frequencies					
	13.000000 to 19.999999 MHz			80	Ohms	All	
	20.000000 to 29.999999 MHz			70	Ohms	All	
	30.000000 to 54.000000 MHz			50	Ohms	All	
	Drive Level	D _L	10	100	300	μW	
	Insulation Resistance	I _R	500			Megohms	100 VDC
Environmental	Aging	Internal Specification					168 hrs. at +55°C
	Physical Dimensions	MIL-STD-883, Method 2016					
	Shock	MIL-STD-202, Method 213 Condition C					100 g
	Vibration	MIL-STD-202, Methods 201 & 204					10 g from 10-2000 Hz
	Thermal Cycle	MIL-STD-883, Method 1010, Condition B					-55°C to +125°C
	Gross Leak	MIL-STD-202, Method 112					30 sec. Immersion
	Fine Leak	MIL-STD-202, Method 112					1 x 10 ⁻⁸ atmcc/sec. min.
	Resistance to Solvents	MIL-STD-883, Method 2015					Three 1 minute soaks
Max Soldering Conditions	See solder profile, Figure 1						

MtronPTI Lead Free Solder Profile

